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Form PTO-1595 (Rev. 03/ 01) OMB No. 0651-0027 (exp. 5/31/2002)		12321	U.S. DEPARTMENT OF COMM U.S. Patent and Trademark
To the Honorable Commissioner of	Patents and Trademarks: P	lease record the attached o	riginal documents or copy the
1. Name of conveying party:		2. Name and address of	of receiving party(ies)
Тае Jin Kang Woon Bok Lee Ц.	2.04	Name: HYNIX SEM	ICONDUCTOR INC.
Additional name(s) of conveying party(ies) Yes X No attached? 3. Nature of Conveyance:		Street Address: San 136-1, Ami-Ri, Bubal-Uep Ichon-Shi, Kyungki-Do	
X Assignment	Merger Change of Name	REPUBLIC OF KOF	
Execution Date: Aug	ust 25, 2003	Additional name(s) & address(es) attached	
4. Application number(s) or pate	ent number(s):	,	*****
If this document is being filed together	with a new application, the ex	ecution date of the new appli	cation is:
A. Patent Application No.: 10/738,691		B. Patent No.(s):	~
<u>م</u>	dditional numbers attach	ed? Yes XNo	
 5. Name and address of party to whom correspondence concerning document should be mailed: Name: Michael R. Hull MARSHALL, GERSTEIN & BORUN LLP Atty. Dkt.: 29936/39862 Street Address: 233 S. Wacker Drive, Suite 6300 Sears Tower 		6. Total number of appl patents involved:	lications and
		7. Total fee (37 CFR 3	3.41) \$ <u>40:00</u>
		Authorized to	be charged to deposit ac be charged to credit card
City: St Chicago IL	ate: Zip: 60606-6357	(Form 2038 enclos 8. Deposit account nu	mber: 13-2855
	DO NOT USE		his page if paying by deposit ac
9. Statement and signature.			
To the best of my knowledge an is a true copy of the original doc		ormation is true and corre	ect and any attached copy
Michael R. Hull - 35,9	02	MANA	March 30, 200
Name of Person Sign		Signature	Date
Total number of page	es including cover sheet, attac	ments, and documents:	3
I hereby certify that this correspondend an envelope addressed to: MS Assign Alexandria, VA 22313-1450, on the da	ment Recordation Services, D		
Dated: March 30, 2004	Signature:	VWI	_ (Michael R. Hull)
LINJELLER 00000007 10738691 40.00 SP			
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REEL: 015160 FRAME: 0408

ASSIGNMENT

Serial No: 10/738,691

Filed: December 17, 2003

Title:Semiconductor device for reducing the number of probing pad used during waferTest and method for testing the same

For good and valuable consideration, the receipt and sufficiency whereof are hereby acknowledged, the undersigned hereby assign(s) to <u>Hynix Semiconductor Inc., of San 136-1, Ami-Ri,</u> <u>Bubal-Uep, Ichon-Shi, Kyungki-Do, Republic of Korea</u>, (hereinafter "Assignee"), its successors and assigns, the entire right, title and interest in the invention or improvements of the undersigned disclosed in an application for Letters Patent of the United States, and in said application and any and all other U.S. applications which the undersigned may file, either solely or jointly with others, on said invention or improvements, and in any and all Letters Patent of the United States which may be obtained on any of said applications, and in any reissue or extension thereof.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue said Letters Patent to said assignee. The undersigned also hereby authorizes the attorneys of Marshall, Gerstein & Borun to insert the filing date and serial number of this application in the blanks above when they become known.

The undersigned warrant(s) themselves (himself/herself) to be the owners (owner) of the interest herein assigned and to have the right to make this assignment and further warrant(s) that there are no outstanding prior assignments, licenses, or other rights in the interest herein assigned.

For said consideration the undersigned hereby agree(s), upon the request and at the expense of said assignee, its successors and assigns, to execute any and all divisional, continuation, continuation-in-part and substitute applications for said invention or improvements, and any necessary oath or affidavit relating thereto, and any application for the reissue or extension of any Letters Patent that may be granted upon said application that said assignee, its successors or assigns, may deem necessary or expedient, and for the aforesaid consideration the undersigned further agree(s) upon the request of said assignee, its successors or assigns, in the event of any application or Letters Patent assigned herein becoming involved in Interference, to cooperate to the best of the ability of the undersigned with said assignee, its successors or assigns, in the matters of preparing and executing the preliminary statement and giving and producing evidence in support thereof, the undersigned hereby agreeing to perform, upon request, any and all affirmative acts to obtain said Letters Patent in the United States and to vest all rights therein hereby conveyed in said assignce, its successors and assigns, whereby said Letters Patent will be held and enjoyed by said assignee, its successors and assigns, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

PATENT REEL: 015160 FRAME: 0409

Attorney Docket: 29936/39862

SIGNED:

Date: _____August 25, 2003

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Date: August 25, 2003

The Jm. Kay Name: Tae Jin KANG

WBLee Name: Woon Bok LEE

RECORDED: 04/02/2004